

Enterprise PCIe 5.0 E3.S SSD Specification X200 Series

Enterprise Secure Storage SSD delivering performance with advanced protection features.

Key Security Features

- Hardware AES-256 Full Drive Encryption: NAS and CISA validated encryption methodology.
- Pre-boot Authentication: NSA and NIST validated PBA, providing a separate, secure authentication prior to initiating boot.
- **Hidden Partitions:** Ability to create eight separate locked partitions where data is locked and unreadable at the sector level, even when the device is in use. User accesses with step-up authentication. Protects against wiping and cloning.
- Crypto and Full Block Erasure: Crypto and block erasure with local and remote execution provides efficient data sanitization for emergency data destruction or storage retirement or repurpose.
- Enterprise Management: Cloud or on-premises console or command line interface (CLI) provides efficient administration at scale.

Technical Specifications

- Product Series: X200
- Capacity:
 - o OP=7%: 1920, 3840, 7680, 15360
 - o OP=28%: 1600, 3200, 6400, 12800
- Form Factor:
 - o E3.S
- PCIe Interface:
 - PCIe Gen5x4
 - Single Port x4 lanes/Dual port 2x2 lanes
 - PCIe AER (Advanced Error Reporting)
- Performance:
 - Maximum Sequential Read/Write
 - Maximum Random Read/Write
 - Latency (Sustained workload)
 - IOPS Consistency
 - QoS (Quality of Service, 99%)¹
- Power Consumption:²
 - Typical Power Consumption: 25 W
 - Inrush Current: 2.5A
 - Idle Power: <9W

- DWPD:
 - 1DWPD -1920, 3840, 7680, 15360
 - o 3DWPD -800, 1600, 3200, 6400, 12800
- TBW:3
 - 1600GB SSD 8760 TB
 - 19200 GB SSD 3504 TB
 - 3200GB SSD 1750 TB
 - 38400GB SSD 7008 TB
 - 7680GB SSD 14016 TB
 - 12800GB SSD 70080 TB
 - 15360GB SSD 28032 TB
- LBAF: 512 / 512+8 / 4K / 4K + 8/4K + 64
 Bytes
- MTBF ⁴
- UBER



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Technical Specifications

- Advanced Flash Management:
 - ECC
 - o Static and Dynamic Wear Leveling
 - Bad Block Management
 - o Deallocate (TRIM) Commane
 - SMART
 - Over-Provision
 - o Firmware Upgrade
- Temperature Range:
 - Operation: 0° ~ 70° C with specified airflow
 - Storage: -40° ~ 85° C
- RoHS Compliant
- Enterprise Features Support List:
 - Namespace
 - Single/Dual Port
 - Reservation
 - Metadata Protection
 - Thermal throttling
 - Power Loss Protection

- Hardware AES-XTS 256-bit Encryption
- Support SMBus
- Support NVMe-MI (Management Interface)
- Data Retention 3 months
- Physical Dimension:
 - 112.75(L)x76(W)x7.45(H) mm³
- Compliance:
 - o PCIe Express Base 5.0
 - NVMe Express 2.0
 - NVMe Express Management Interface Rev 1.2
 - PCIe Express SFF-8639 Module
 Specification Revision 4.0, Version1.0

Notes:

- 1. Please see "Performance to Quality of Service (QoS)" Chapter 2.5 for details.
- 2. Please see "Power Consumption" Chapter 4.2 for details.
- 3. Please see "TBW (Terabytes Written)" Chapter 3.2 for details.
- 4. MTBF is a prediction simulation based on Telcordia SR-332 model.